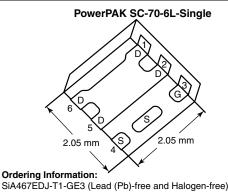


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Vishay Siliconix

P-Channel 12 V (D-S) MOSFET

PRODU	CT SUMMARY			
V _{DS} (V)	R _{DS(on)} (Ω) (Max.)	I _D (A) ^a	Q _g (Typ.)	
- 12	0.0130 at V _{GS} = - 4.5 V	- 31		
	0.0145 at V _{GS} = - 3.7 V	- 30	29 nC	
	0.0195 at V _{GS} = - 2.5 V	- 26	29110	
	0.0400 at V _{GS} = - 1.8 V	- 7		



FEATURES

- TrenchFET® Power MOSFET
- Thermally Enhanced PowerPAK® SC-70 Package
 - Small Footprint Area
 - Low On-Resistance
- 100 % R_q and UIS Tested
- Typ ESD Protection: 5000 V (HBM)
- · Material categorization: For definitions of compliance please see www.vishay.com/doc?99912

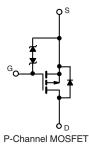
Lot Traceability

and Date code

APPLICATIONS

- · Portable Devices such as Smart Phones, Tablet PCs and Mobile Computing
 - Battery Switch
 - Load Switch
 - Power Management

Marking Code Part # code $\overline{\mathsf{x}} \times \overline{\mathsf{x}}$



COMPLIANT

HALOGEN

FREE

Parameter	Symbol	Limit	Unit		
Drain-Source Voltage		V _{DS}	- 12	V	
Gate-Source Voltage		V _{GS}	± 8		
	T _C = 25 °C		- 31		
Continuous Duois Comment (T. 150 °C)	T _C = 70 °C		- 25		
Continuous Drain Current (T _J = 150 °C)	T _A = 25 °C	I _D	- 13 ^{b, c}		
	T _A = 70 °C		- 11 ^{b, c}		
Pulsed Drain Current (t = 300 μs)		I _{DM}	- 60	A	
Continuous Source-Drain Diode Current	T _C = 25 °C		- 16		
	T _A = 25 °C	I _S	- 2.9 ^{b, c}		
Single Avalanche Current		I _{AS}	- 11		
Single Avalanche Energy	L = 0.1 mH	E _{AS}	5.8	mJ	
Maximum Power Dissipation	T _C = 25 °C		19		
	T _C = 70 °C	D	12	10/	
	T _A = 25 °C	P _D	3.5 ^{b, c}	W	
	T _A = 70 °C		2.2 ^{b, c}		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 50 to 150	°C	
Soldering Recommendations (Peak Temperature) ^{d, e}		,	260		

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^{b, f}	t ≤ 5 s	R_{thJA}	28	36	°C/W	
Maximum Junction-to-Case (Drain)	Steady State	R_{thJC}	5.3	6.5	C/W	

Notes

- a. $T_C = 25$ °C.
- Surface mounted on 1" x 1" FR4 board.
- See solder profile (www.vishay.com/doc?73257). The PowerPAK SC-70 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- Rework conditions: manual soldering with a soldering iron is not recommended for leadless components.
- Maximum under steady state conditions is 80 °C/W.



SiA467EDJ

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static						l	
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	- 12			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$			- 6.4		mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I _D = - 250 μA		2.4			
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \mu\text{A}$	- 0.4		- 1	V	
0.1.0	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 8 \text{ V}$			± 2		
Gate-Source Leakage		$V_{DS} = 0 \text{ V}, V_{GS} = \pm 4.5 \text{ V}$			± 0.5	μΑ	
	I _{DSS}	V _{DS} = - 12 V, V _{GS} = 0 V			- 1		
Zero Gate Voltage Drain Current		V _{DS} = - 12 V, V _{GS} = 0 V, T _J = 55 °C			- 10	1	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \le -5 \text{ V}, V_{GS} = -4.5 \text{ V}$	- 10			Α	
		V _{GS} = - 4.5 V, I _D = - 5 A		0.0105	0.0130		
Dunin Course On Chata Basistanas		$V_{GS} = -3.7 \text{ V}, I_D = -5 \text{ A}$		0.0120	0.0145	Ω	
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = - 2.5 V, I _D = - 4 A		0.0155	0.0195		
		V _{GS} = - 1.8 V, I _D = - 2 A		0.0260	0.0400		
Forward Transconductance ^a	9 _{fs}	$V_{GS} = -6 \text{ V}, I_D = -5 \text{ A}$		31		S	
Dynamic ^b				•			
Input Capacitance	C _{iss}			2520		pF	
Output Capacitance	C _{oss}	$V_{DS} = -6 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		570			
Reverse Transfer Capacitance	C _{rss}			545			
Total Cata Chayea	Qg	V _{DS} = -6 V, V _{GS} = -8 V, I _D = -14 A		48	72		
Total Gate Charge				29	44	nC	
Gate-Source Charge	Q_{gs}	$V_{DS} = -6 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -14 \text{ A}$		4			
Gate-Drain Charge	Q_{gd}			6.6			
Gate Resistance	R_g	f = 1 MHz	1.8	9	18	Ω	
Turn-On Delay Time	t _{d(on)}			25	50		
Rise Time	t _r	$V_{DD} = -6 \text{ V}, R_L = 0.6 \Omega$ $I_D \cong -10 \text{ A}, V_{GEN} = -4.5 \text{ V}, R_g = 1 \Omega$		25	50		
Turn-Off Delay Time	t _{d(off)}			90	180		
Fall Time	t _f			50	100		
Turn-On Delay Time	t _{d(on)}			10	20	ns	
Rise Time	t _r	$V_{DD} = -6 \text{ V}, R_{L} = 0.6 \Omega$		10	20		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong -10$ A, $V_{GEN} = -8$ V, $R_g = 1$ Ω		120	240		
Fall Time	t _f			45	90		
Drain-Source Body Diode Characterist	ics						
Continuous Source-Drain Diode Current	IS	T _C = 25 °C			- 16	А	
Pulse Diode Forward Current	I _{SM}				- 60		
Body Diode Voltage	V_{SD}	I _S = - 10 A, V _{GS} = 0 V		- 0.75	- 1.2	V	
Body Diode Reverse Recovery Time t _{rr}				20	40	ns	
Body Diode Reverse Recovery Charge		1 10 A dI/d+ 100 A / T 05 00		7	15	nC	
Reverse Recovery Fall Time	ta	I _F = - 10 A, dl/dt = 100 A/µs, T _J = 25 °C		9			
Reverse Recovery Rise Time	t _b			11		ns	

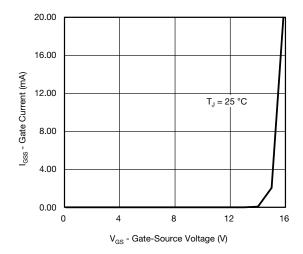
Notes

- a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.
- b. Guaranteed by design, not subject to production testing.

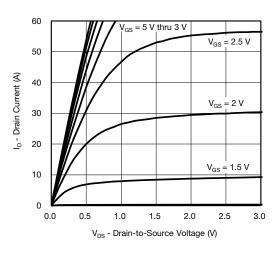
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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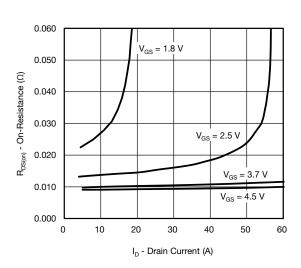
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



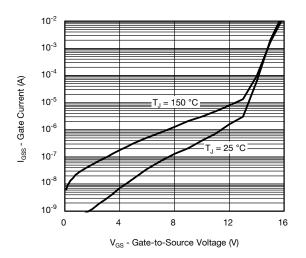
Gate Current vs. Gate-Source Voltage



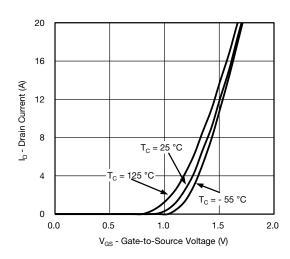
Output Characteristics



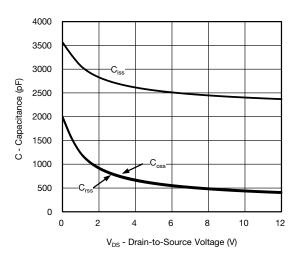
On-Resistance vs. Drain Current and Gate Voltage



Gate Current vs. Gate-to-Source Voltage



Transfer Characteristics

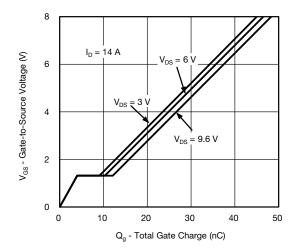


Capacitance

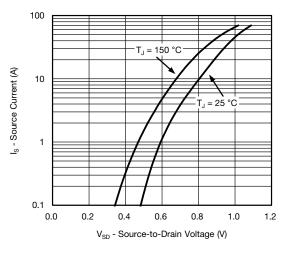
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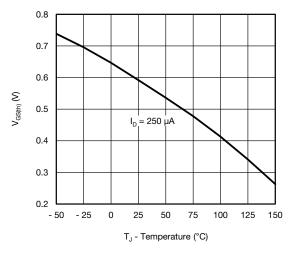
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



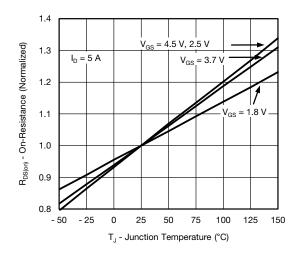
Gate Charge



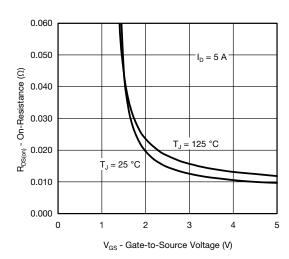
Soure-Drain Diode Forward Voltage



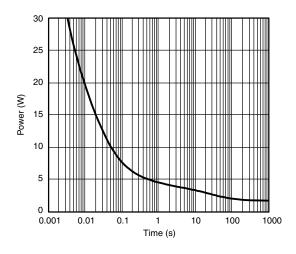
Threshold Voltage



On-Resistance vs. Junction Temperature



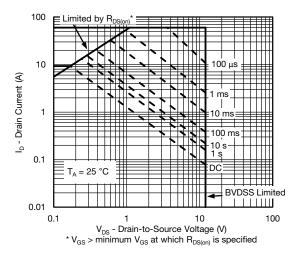
On-Resistance vs. Gate-to-Source Voltage



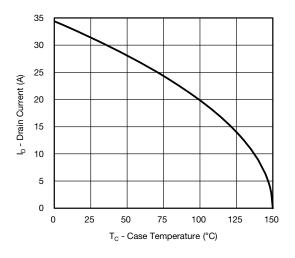
Single Pulse Power, Junction-to-Ambient

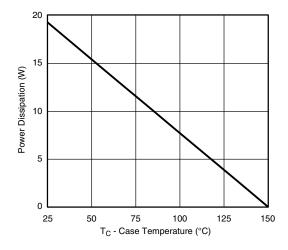
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Safe Operating Area, Junction-to-Ambient





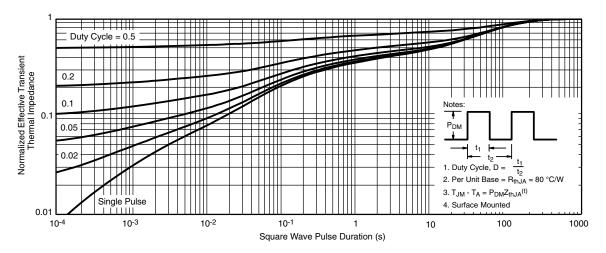
Current Derating*

Power Derating

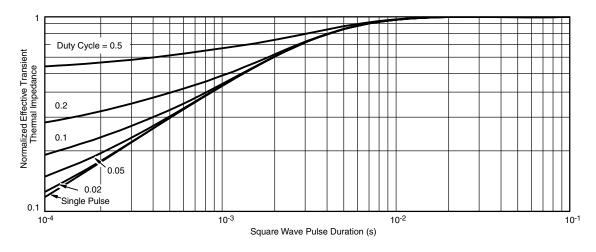
^{*} The power dissipation P_D is based on $T_{J(max.)}$ = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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